

Electronic Ignition Control Circuit

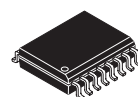
The 79076, in conjunction with an appropriate Freescale Power Darlington Transistor, provides an economical solution for automotive ignition applications. The 79076 offers optimum performance by providing closed loop operation of the Power Darlington in controlling the ignition coil current.

Features

- Hall or Variable Reluctance Sensor Input
- Ignition Coil Voltage Internally Limited to 375 V
- Coil Current Limiting to 7.5 A
- Output On-Time (Dwell) Control
- Dwell Feedback Control to Sense Coil Variation
- Pb-Free Packaging Designated by Suffix Code EG

79076

ELECTRONIC IGNITION CONTROL CIRCUIT



**DW SUFFIX
EG (PB-FREE) SUFFIX
98ASB42567B
16-PIN SOIC**

ORDERING INFORMATION

Device	Temperature Range (T _A)	Package
MC79076DW/R2	-30°C to 125°C	16 SOIC
MCZ79076EG/R2		

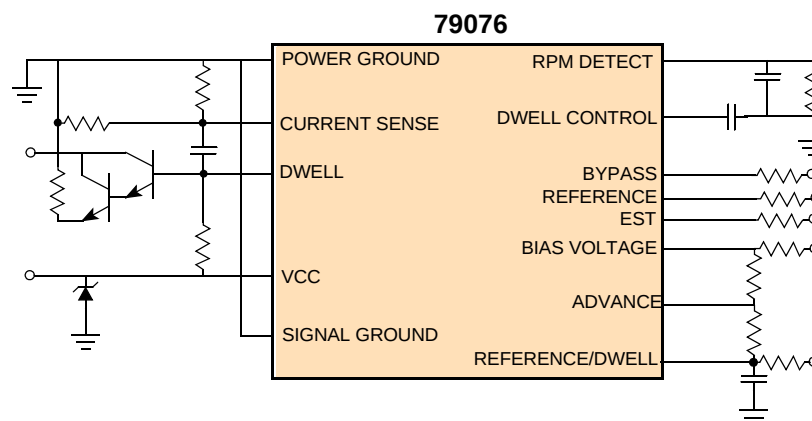


Figure 1. 79076 Simplified Application Diagram

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INTERNAL BLOCK DIAGRAM

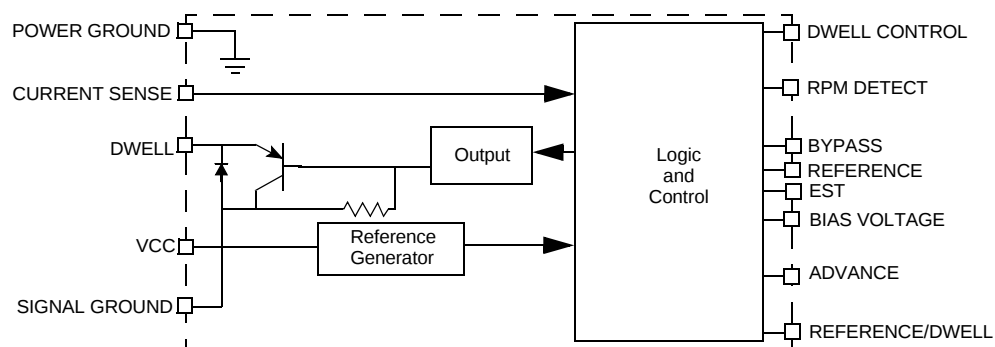


Figure 2. 79076 Simplified Internal Block Diagram

PIN CONNECTIONS

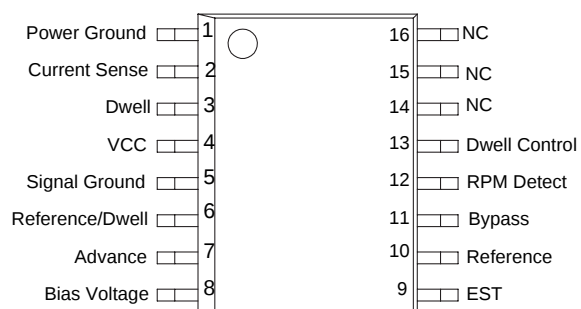


Figure 3. 79076 Pin Connections

ELECTRICAL CHARACTERISTICS

MAXIMUM RATINGS

Table 1. Maximum Ratings

All voltages are with respect to ground unless otherwise noted. Exceeding these ratings may cause a malfunction or permanent damage to the device.

Ratings	Symbol	Value	Unit
ELECTRICAL RATINGS			
Supply Voltage Steady-State Transient Conditions ⁽¹⁾	$V_{CC(SUS)}$ $V_{CC(PK)}$	36 50	V
Supply Current Transient Conditions ⁽²⁾ Transient Negative Current ($t_T = 60ms$) Transient Negative Current ($t_T = 1ms$)	I_T	1.0 -100 -1.3	A mA A
Input Voltage ⁽³⁾ Ref/Dwell, Advance EST, Bypass	V_{IN1} V_{IN2}	-5.0 to 30 -5.0 to 24	V
Ref/Dwell Input Current	I_{IN1}	-20	mA
Dwell ON Sink Current Output ON (Operating) Output ON ($t = 10ms$)	I_D	0.3 0.8	A
Dwell OFF Voltage ⁽⁴⁾	$V_{D(OFF)}$	5.0	V
THERMAL RATINGS			
Storage Temperature	T_{STG}	-65 to 150	°C
Operating Ambient Temperature	T_A	-30 to 125	°C
THERMAL RESISTANCE			
Operating Junction Temperature	T_J	-30 to 150	°C
Thermal Resistance (Junction-to-Ambient) - SO8	θ_{J-A}	80	°C/W
Peak Package Reflow Temperature During Reflow ^{(5), (6)}	T_{PPRT}	Note 6	°C

Notes

- Survivability of device with transient voltage applied to V_{CC} pin for a duration not to exceed 10ms.
- Survivability of device with overvoltage applied to V_{CC} pin producing the current for a duration not to exceed 10ms.
- Exceeding this voltage range on the function pin may cause permanent damage to the device.
- A zener diode is incorporated across collector to emitter of the output NPN device to prevent voltage overdrive of the external Darlington switch transistor.
- Pin soldering temperature limit is for 10 seconds maximum duration. Not designed for immersion soldering. Exceeding these limits may cause malfunction or permanent damage to the device.
- Freescall's Package Reflow capability meets Pb-free requirements for JEDEC standard J-STD-020C. For Peak Package Reflow Temperature and Moisture Sensitivity Levels (MSL), Go to www.freescale.com, search by part number [e.g. remove prefixes/suffixes and enter the core ID to view all orderable parts. (i.e. MC33xxx enter 33xxx), and review parametrics.

STATIC ELECTRICAL CHARACTERISTICS

Table 2. Static Electrical Characteristics

Characteristics noted under conditions $7.0\text{ V} \leq V_{CC} \leq 18\text{ V}$, $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$, $GND = 0\text{ V}$ unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25^\circ\text{C}$ under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Typ	Max	Unit
INPUTS					
Advance Input Resistance ($V_{CC} = 16\text{ V}$, Ref/Dwell = 1.0 V, Advance = 1.0 mA, EST = Bypass = 0 V)	$R_{(A)}$	15	18	25	$k\Omega$
Advance Voltage ⁽⁷⁾ $V_{CC} = 16\text{ V}$, Ref/Dwell = 1.0 V, EST = Bypass = 0 V	$V_{TH(A)}$	-	0.05	0.1	V
Advance Threshold Voltage ⁽⁷⁾ ($V_{CC} = 16\text{ V}$, Ref/Dwell = 1.0 V, EST = Bypass = 0 V, Dwell = Reference = RPM Detect = open, Dwell Control = sinking 10 μA) Increasing Decreasing Hysteresis	$V_{TH+(A)}$ $V_{TH-(A)}$ $V_{HYS(A)}$	$V_B + 0.103$ $V_B + 0.045$ 0.018	$V_B + 0.114$ $V_B + 0.068$ 0.045	$V_B + 0.130$ - -	V
Bypass Input Resistance ($V_{CC} = 16\text{ V}$, Ref/Dwell = Advance = 3.0 V, EST = Bypass = 0 V)	$R_{(BP)}$	6.0	9.2	16	$k\Omega$
Bypass Voltage ($V_{CC} = 16\text{ V}$, Ref/Dwell = Advance = 1.0 V, EST = 0V)	$V_{(BP)}$	-	0.065	0.1	V
Bypass Threshold Voltage ⁽⁸⁾ (Ref/Dwell = Advance = 1.0 V, EST = 3.0 V) Increasing Decreasing Hysteresis	$V_{TH+(BP)}$ $V_{TH-(BP)}$ $V_{HYS(BP)}$	$V_B + 1.6$ $V_B + 0.9$ 0.65	$V_B + 0.188$ $V_B + 0.103$ 0.86	$V_B + 2.1$ - -	V
Current Sense Threshold Voltage ⁽⁹⁾ ($V_{CC} = 16\text{ V}$, Ref/Dwell = Advance = 1.0 V, EST = Bypass = 3.0 V)	$V_{TH(CS)}$	90	105	121	mV
EST Input Resistance ($V_{CC} = 16\text{ V}$, Ref/Dwell = Advance = 1.0 V, Bypass = 3.0 V)	$R_{(EST)}$	7.0	10.3	18	$k\Omega$
EST Input Voltage (EST Mode) ($V_{CC} = 16\text{ V}$, Ref/Dwell = Advance = 1.0 V, Bypass = 3.0 V)	$V_{(EST)}$	-	0.07	0.1	V

Notes

- Advance Threshold Voltage is the positive (or negative) going voltage on Advance necessary cause the Dwell Control voltage to positive (or negative) going transition 2.0 V respectively. It is expressed as $V_{TH\pm(A)} = V_B + V_X$ where V_B is the Bias Voltage and V_X is the additional voltage necessary to attain the threshold.
- Bypass Threshold Voltage is the positive (or negative) going voltage on Bypass necessary cause the Dwell voltage to positive (or negative) going transition 1.5 V respectively. It is expressed as $V_{TH\pm(BP)} = V_B + V_X$ where V_B is the Bias Voltage and V_X is the additional voltage necessary to attain the threshold.
- Increasing voltage on Current Sense which when attained will cause Dwell to transition low to 1.5 V with a 10 mA load.

Table 2. Static Electrical Characteristics (continued)

Characteristics noted under conditions $7.0\text{ V} \leq V_{CC} \leq 18\text{ V}$, $-40^{\circ}\text{C} \leq T_A \leq 125^{\circ}\text{C}$, $\text{GND} = 0\text{ V}$ unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25^{\circ}\text{C}$ under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Typ	Max	Unit
EST Threshold Voltage ⁽¹⁰⁾ (Ref/Dwell = Advance = 1.0 V, Bypass = 3.0 V)					V
Increasing	$V_{TH+(EST)}$	1.65	1.86	2.0	
Decreasing	$V_{TH-(EST)}$	0.8	0.89	-	
Hysteresis	$V_{HYS(EST)}$	0.79	0.97	-	
Ref/Dwell Current ⁽¹¹⁾ ($V_{CC} = 16\text{ V}$, Advance = 1.0 V, EST = Bypass = 0 V) Ref/Dwell Voltage = 1.0 V Ref/Dwell Voltage = 20 V	$I_{(R/D)}$				μA
		-12	-1.38	1.0	
		-1.0	0.02	5.0	
Ref/Dwell Clamp Voltage ($V_{CC} = 16\text{ V}$, Advance = 1.0 V, EST = Bypass = 0 V) $I_{R/D} = 100\mu\text{A}$ (Sourcing) $I_{R/D} = 1.0\text{mA}$ (Sourcing)	$V_{(R/D)CL}$				V
		-0.01	-0.04	0.2	
		-0.62	-0.54	-	
Ref/Dwell Threshold (Bypass Mode) ⁽¹²⁾ (Advance = 1.0 V, EST = Bypass = 0 V, Reference = sinking 10 μA)					V
Increasing	$V_{TH+(R/D)BP}$	$V_B + 0.09$	$V_B + 0.106$	$V_B + 0.116$	
Decreasing	$V_{TH-(R/D)BP}$	$V_B + 0.018$	$V_B + 0.03$	-	
Hysteresis	$V_{HYS(R/D)BP}$	0.055	0.076	-	
Ref/Dwell Threshold (EST Mode) ⁽¹²⁾ (Advance = 1.0 V, EST = 0 V, Bypass = 3.0 V, Reference = sinking 10 μA)					V
Increasing	$V_{TH+(R/D)EST}$	$V_B + 0.445$	$V_B + 0.50$	$V_B + 0.535$	
Decreasing	$V_{TH-(R/D)EST}$	$V_B + 0.038$	$V_B + 0.062$	-	
Hysteresis	$V_{HYS(R/D)EST}$	0.395	0.436	-	
Ref/Dwell Threshold (No Pump) ⁽¹³⁾ (Advance = 1.0 V, EST = Bypass = 0 V, Dwell = sinking 10 mA)					V
Increasing	$V_{TH+(R/D)NP}$	$V_B + 0.003$	$V_B + 0.118$	$V_B + 0.128$	
Decreasing	$V_{TH-(R/D)NP}$	$V_B + 0.021$	$V_B + 0.047$	-	
Hysteresis	$V_{HYS(R/D)NP}$	$V_B + 0.013$	$V_B + 0.072$	-	

Notes

- EST Threshold Voltage is the positive (or negative) going voltage on EST necessary cause the Dwell voltage to positive (or negative) going transition 1.5 V respectively. It is expressed as $V_{TH\pm(EST)}$ and is in reference to ground.
- Ref/Dwell can either source or sink current; A minus sign denotes the Ref/Dwell is sourcing current.
- Ref/Dwell Threshold Voltage (Bypass Mode) is the positive (or negative) going voltage on Ref/Dwell necessary cause the Reference voltage to positive (or negative) going transition 1.5 V respectively. It is expressed as $V_{TH\pm(RD)} = V_B + V_X$ where V_B is the Bias Voltage and V_X is the additional voltage necessary to attain the threshold.
- Ref/Dwell Threshold Voltage (No Pump) is the positive (or negative) going voltage on Ref/Dwell necessary cause the Dwell voltage to positive (or negative) going transition 1.5 V respectively. It is expressed as $V_{TH\pm(RD)} = V_B + V_X$ where V_B is the Bias Voltage and V_X is the additional voltage necessary to attain the threshold. Advance = 1.0 V providing no input assist or "No Pump" influence of Dwell signal; Reference open.

Table 2. Static Electrical Characteristics (continued)

Characteristics noted under conditions $7.0\text{ V} \leq V_{CC} \leq 18\text{ V}$, $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$, $\text{GND} = 0\text{ V}$ unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25^\circ\text{C}$ under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Typ	Max	Unit
Ref/Dwell Threshold (Max Pump) ⁽¹⁴⁾ ($V_{CC} = 16\text{ V}$, Advance = 3.0 V, EST = Bypass = 0 V, Dwell sinking 10 mA, Dwell Control = open) Increasing Decreasing Hysteresis	$V_{TH+(R/D)MP}$ $V_{TH-(R/D)MP}$ $V_{HYS(R/D)MP}$	$V_B + 0.175$ $V_B + 0.115$ $V_B + 0.025$	$V_B + 0.474$ $V_B + 0.425$ $V_B + 0.048$	$V_B + 0.80$ $V_B + 0.735$ -	V

OUTPUTS

Bias Resistance to Ground Dwell = V_{CC} = Ref/Dwell = Reference = Dwell Control = open, Advance = 1.0 V, EST = Bypass = 0 V	$R_{(B)}$	0.55	0.68	0.9	k Ω
Bias Voltage (Bypass Mode) Ref/Dwell = Advance = 1.0 V, EST = Bypass = 0 V	$V_{(B)BP}$	2.25	2.43	2.6	V
Bias Voltage Regulation (Bypass Mode) Ref/Dwell = Advance = 1.0 V, EST = Bypass = 0 V	$V_{(B)BP}$	-	30	40	mV
Bias Voltage (EST Mode) $V_{CC} = 16\text{ V}$, Ref/Dwell = Advance = 1.0 V, EST = 0 V, Bypass = 3.0 V	$V_{(B)EST}$	1.9	2.04	2.2	V
Dwell Saturation Voltage $V_{CC} = 4.0\text{ V}$, $I_D = 40\text{ mA}$, Ref/Dwell = Advance = 3.0 V, EST = Bypass = 0 V $V_{CC} = 16\text{ V}$, $I_D = 160\text{ mA}$, Ref/Dwell = Advance = 3.0 V, EST = Bypass = 0 V $V_{CC} = 24\text{ V}$, $I_D = 240\text{ mA}$, Ref/Dwell = Advance = 1.0 V, EST = Bypass = 3.0 V $V_{CC} = 36\text{ V}$, $I_D = 360\text{ mA}$, Ref/Dwell = Advance = 1.0 V, EST = Bypass = 3.0 V	$V_{(D)SAT}$	- - - -	0.05 0.14 0.20 0.29	0.1 0.24 0.35 0.5	V
Dwell Reverse Clamp Voltage ⁽¹⁵⁾	$V_{(D)REV}$	-0.9	-0.98	-1.2	V
Dwell Leakage Current ⁽¹⁶⁾ $V_{CC} = 16\text{ V}$, Dwell = 5.0 V, Ref/Dwell = Advance = 3.0 V, EST = Bypass = 0, Bias Voltage = Reference = open	$I_{(D)KG}$	-	0.044	50	μA
Reference Low ⁽¹⁷⁾ I_R = sinking 0.3 mA, Ref/Dwell = Advance = 1.0 V, EST = Bypass = 0 V	$V_{(R)LOW}$	-	0.13	0.22	V

Notes

14. Ref/Dwell Threshold Voltage (Max Pump) is the positive (or negative) going voltage on Ref/Dwell necessary cause the Dwell voltage to positive (or negative) going transition 1.5 V respectively. It is expressed as $V_{TH\pm(RD)} = V_B + V_X$ where V_B is the Bias Voltage and V_X is the additional voltage necessary to attain the threshold. Advance = 3.0 V providing maximum input assist or Max Pump" influence of Dwell signal; Reference = Dwell Control = open.
15. All pins open except Pwr Gnd with Dwell sinking 200 mA.
16. Limit conditions with Dwell output NPN in the OFF condition.
17. Reference saturation voltage to ground with 0.3mA of current going into the Reference.

Table 2. Static Electrical Characteristics (continued)

Characteristics noted under conditions $7.0\text{ V} \leq V_{CC} \leq 18\text{ V}$, $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$, $GND = 0\text{ V}$ unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25^\circ\text{C}$ under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Typ	Max	Unit
Reference High/Un-Clamped ⁽²⁷⁾ $V_{CC} = 4.0\text{ V}$, $I_R = \text{sourcing } 100\text{ }\mu\text{A}$, Ref/Dwell = 3.0 V , Advance = 1.0 V , EST = Bypass = 0 V	$V_{(R)HI/UNCL}$	3.2	3.36	-	V
Reference High/Clamped ⁽²⁷⁾ $V_{CC} = 16\text{ V}$, Ref/Dwell = 3.0 V , Advance = 1.0 V , EST = Bypass = 0 V $I_R = \text{sourcing } 10\text{ }\mu\text{A}$ $I_R = \text{sourcing } 1.0\text{ mA}$	$V_{(R)HI/CL}$	- 12	5.41 15.3	6.0 -	V

CONTROLS

Dwell Control Negative Clamp Voltage ⁽²⁷⁾ $V_{CC} = 16\text{ V}$, $I_{DC} = \text{sourcing } 100\text{ }\mu\text{A}$, Ref/Dwell = Advance = 1.0 V , EST = Bypass = 0 V	$V_{(DC)CL}$	0.5	0.7	0.8	V
Dwell Control Positive Clamp Voltage ⁽²⁷⁾ $V_{CC} = 16\text{ V}$, $I_{DC} = \text{sinking } 100\text{ }\mu\text{A}$, Ref/Dwell = 1.0 V , Advance = Open, EST = Bypass = 0 V	$V_{(DC)+CL}$	8.0	8.2	8.4	V
Dwell Control Charge Current ⁽²⁷⁾ $V_{CC} = 16\text{ V}$, Ref/Dwell = 1.0 V , Advance = Dwell Control = 3.0 V , EST = Bypass = 0 V	$I_{(DC)CHG}$	30	47	58	μA
Dwell Control Discharge Current ⁽²⁷⁾ $V_{CC} = 16\text{ V}$, Current Sense = 0.5 V , Ref/Dwell = Advance = 1.0 V , EST = Bypass = 0 V	$I_{(DC)DISCHG}$	18	33	48	μA
Dwell Control Input Current ⁽²⁷⁾ $V_{CC} = 16\text{ V}$, Ref/Dwell = Advance = 1.0 V , EST = Bypass = 0 V , Dwell Control = 7.0 V	$I_{(DC)SINK}$	-	1.1	2.5	μA
RPM Detect Charge Current ON ⁽²⁷⁾ $V_{CC} = 16\text{ V}$, Ref/Dwell = 3.0 V , Advance = 1.0 V , EST = Bypass = 0 V	$I_{(RPM)CHG}$	-4.0	0.54	1.0	mA
RPM Detect Current ⁽²⁷⁾ $V_{CC} = 16\text{ V}$, $1.0\text{ V} = \text{Ref/Dwell} = \text{Advance} = 3.0\text{ V}$, EST = Bypass = 0 V RPM Detect = 0.5 V RPM Detect = 1.5 V	$I_{(RPM)LKG}$	04.0 -0.1	0.55 0.01	1.0 0.1	μA
RPM Detect Clamp Voltage ⁽²⁷⁾ $V_{CC} = 16\text{ V}$, Ref/Dwell = 3.0 V , Advance = 1.0 V , EST = Bypass = 0 V , RPM Detect = sourcing $16\text{ }\mu\text{A}$	$V_{(RPM)CL}$	2.4	2.5	2.7	V

Notes

18. Dwell Control adjusts the reference voltage of Dwell Comparator.
19. Dwell Control. sourcing $100\text{ }\mu\text{A}$.
20. Dwell Control sinking $100\text{ }\mu\text{A}$.
21. Dwell Control at 3.0 V ; Internal Dwell Control transistor OFF.
22. Dwell Control at 3.0 V ; Internal Dwell Control transistor ON.
23. Dwell Control at 7.0 V ; Internal Dwell Control transistor OFF.
24. Q53 and Q54 both ON; Measured with RPM Detect voltage at 0.5 V to reflect maximum source current capability. See [Typical Applications on page 10](#)
25. Q53 and Q54 both OFF; Measured with RPM Detect voltage at 0.5 V and 1.5 V to reflect maximum leakage current. [Typical Applications on page 10](#)
26. Q53 and Q54 both ON; RPM Detect sinking $16\text{ }\mu\text{A}$. [Typical Applications on page 10](#)

Table 2. Static Electrical Characteristics (continued)

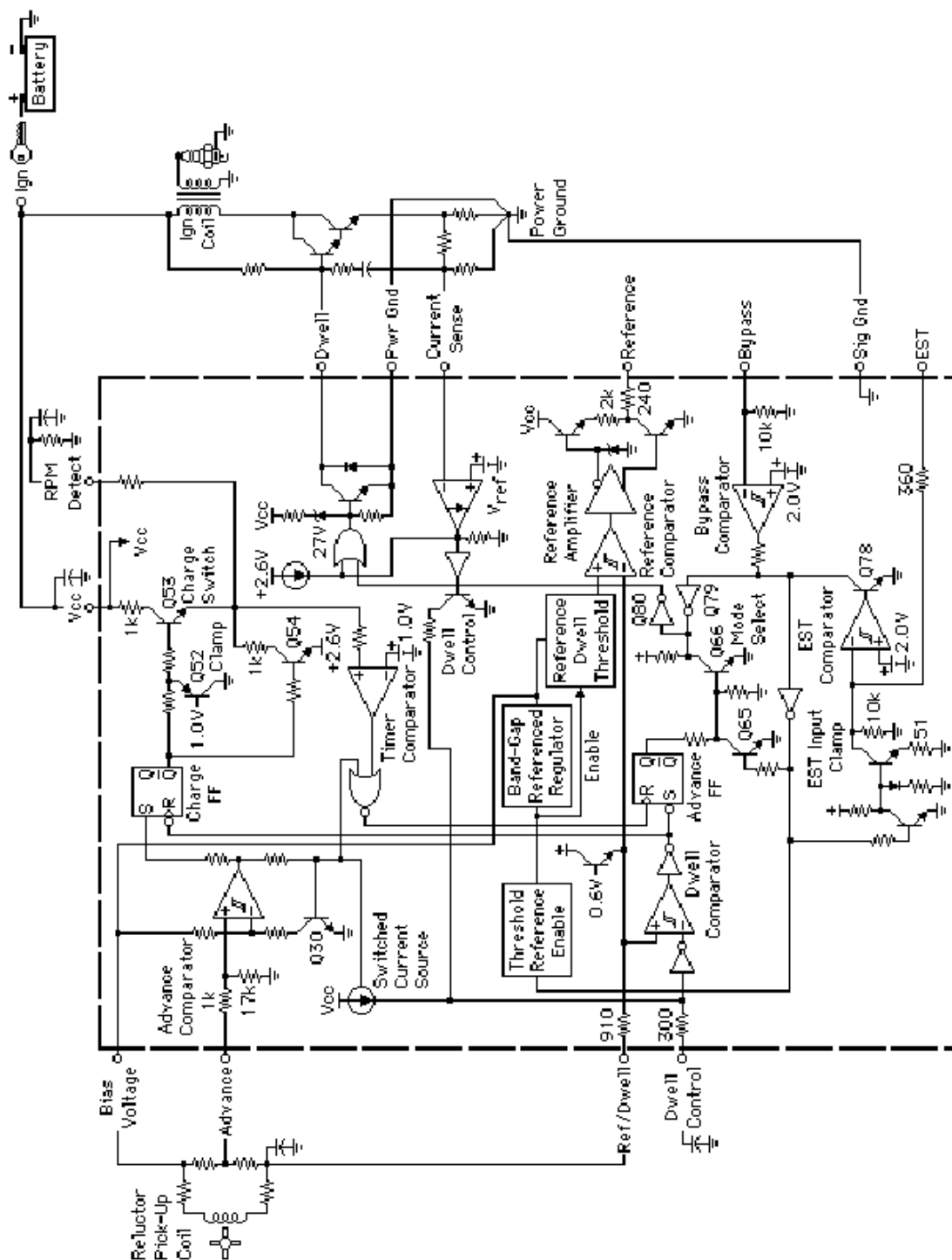
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Characteristic	Symbol	Min	Typ	Max	Unit
RPM Detect Threshold ⁽²⁷⁾ $V_{CC} = 16\text{ V}$, Ref/Dwell = Advance = 3.0 V , EST = Bypass = 0 V	$V_{TH-(RPM)}$	0.8	0.92	1.0	V
RPM Detect Charge Current $V_{CC} = 16\text{ V}$, Ref/Dwell = 3.0 V , Advance = 1.0 V , EST = Bypass = 0 V	$I_{(RPM)CHG}$	-	-2.0	-	mA

Notes

27. Decreasing Threshold; RPM Detect voltage decreased from 0.6 V until Dwell voltage transitions low to 1.5 V with 10 mA load.

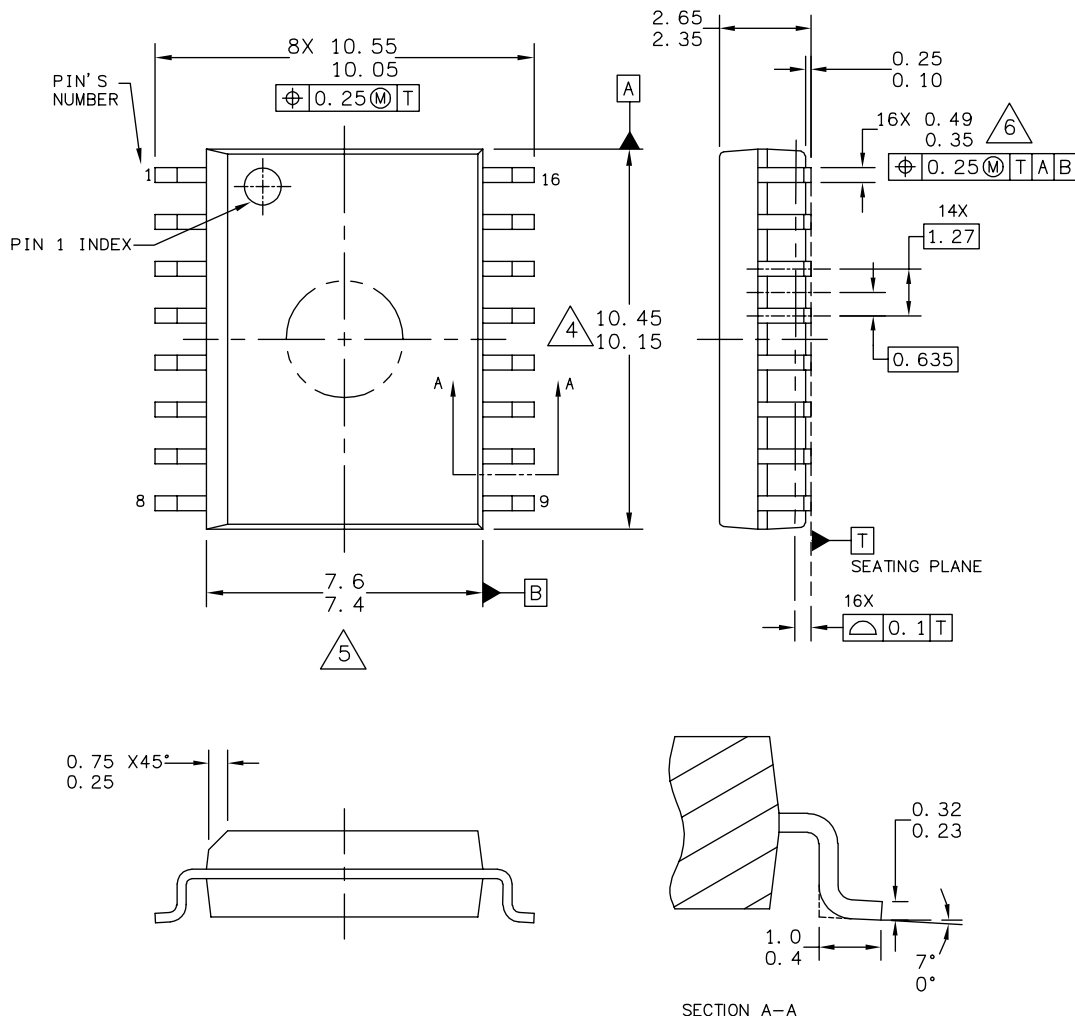
TYPICAL APPLICATIONS



PACKAGING

PACKAGE DIMENSIONS

For the most current package revision, visit www.freescale.com and perform a keyword search using the “98A” listed below.



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	CASE NUMBER: 751G-04	02 JUN 2005
	STANDARD: JEDEC MS-013AA	

DW SUFFIX
EG SUFFIX (PB-FREE)
16-PIN
PLASTIC PACKAGE
98ASB42567B
ISSUE F

REVISION HISTORY

REVISION	DATE	DESCRIPTION OF CHANGES
3.0	3/2007	• Implemented Revision History page • Converted to Freescale format • Added MCZ79076EG/R2 to the Ordering Information • Removed MCCF79076 and all corresponding references.

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